



BSI Standards Publication

Test methods for electrical materials, printed boards and other interconnection structures and assemblies

Part 5-4: General test methods for materials and assemblies — Solder alloys and fluxed and non-fluxed solid wire for printed board assemblies

National foreword

This British Standard is the UK implementation of EN 61189-5-4:2015. It is identical to IEC 61189-5-4:2015. It supersedes BS IEC 61189-5-4:2015, which is withdrawn.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its secretary.

This publication does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

© The British Standards Institution 2015.
Published by BSI Standards Limited 2015

ISBN 978 0 580 90020 4

ICS 31.180

Compliance with a British Standard cannot confer immunity from legal obligations.

This British Standard was published under the authority of the Standards Policy and Strategy Committee on 31 January 2015.

Amendments/corrigenda issued since publication

Date	Text affected
30 April 2015	This corrigendum renumbers BS IEC 61189-5-4:2015 as BS EN 61189-5-4:2015.